

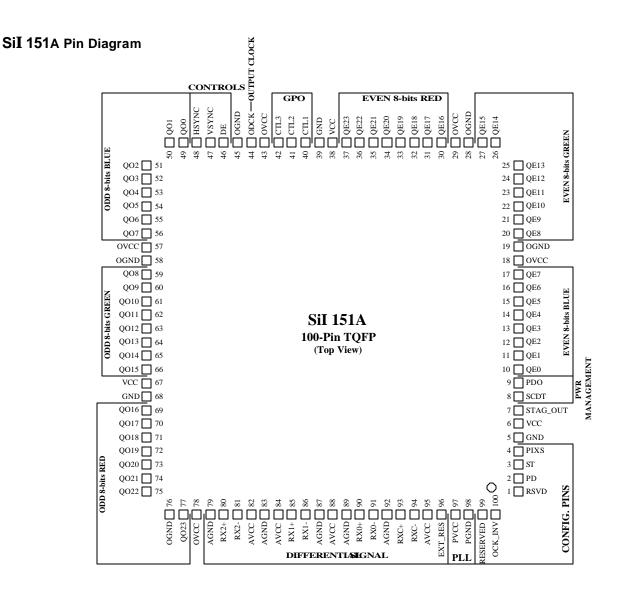
#### **General Description**

The SiI 151A receiver uses PanelLink Digital technology to support high resolution displays up to SXGA. The SiI 151A receiver supports up to true color panels (24 bit/pixel, 16.7M colors) in 1 or 2 pixels/clock mode. In addition, the receiver data output is time staggered to reduce ground bounce that affects EMI. Since all PanelLink products are designed on scaleable CMOS architecture to support future performance requirements while maintaining the same logical interface, system designers can be assured that the interface will be fixed through a number of technology and performance generations.

PanelLink Digital technology simplifies PC and display interface design by resolving many of the system level issues associated with high-speed mixed signal design, providing the system designer with a digital interface solution that is quicker to market and lower in cost.

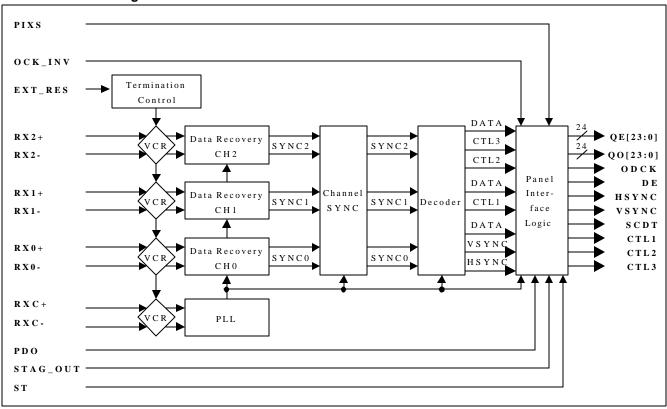
#### **Features**

- Low Power: 3.3V core operation
- Time staggered data output for reduced ground bounce
- Sync Detect: for Plug & Display "Hot Plugging"
- Cable Distance Support: over 5m with twisted-pair, fiber-optics ready
- Compliant with DVI 1.0 (DVI is backwards compatible with VESA® P&D<sup>TM</sup> and DFP)





## **Functional Block Diagram**



## **Absolute Maximum Conditions**

Symbol	Parameter	Min	Тур	Max	Units
$V_{cc}$	Supply Voltage 3.3V	-0.3		4.0	V
Vı	Input Voltage	-0.3		V <sub>cc</sub> + 0.3	V
Vo	Output Voltage	-0.3		V <sub>cc</sub> + 0.3	V
T <sub>A</sub>	Ambient Temperature (with power applied)	-25		105	°C
T <sub>STG</sub>	Storage Temperature	-40		125	°C
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)		53		°C/W

Notes: <sup>1</sup>Permanent device damage may occur if absolute maximum conditions are exceeded.

**Normal Operating Conditions** 

Symbol	Parameter	Min	Тур	Max	Units
$V_{cc}$	Supply Voltage	3.00	3.3	3.6	V
$V_{CCN}$	Supply Voltage Noise			100	$mV_{P-P}$
T <sub>A</sub>	Ambient Temperature (with power	0	25	70	°C
	applied)				

<sup>&</sup>lt;sup>2</sup> Functional operation should be restricted to the conditions described under Normal Operating Conditions.

## DC Digital I/O Specifications

Under normal operating conditions unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V <sub>IH</sub>	High-level Input		2			V
	Voltage					
$V_{IL}$	Low-level Input				0.8	V
	Voltage					
$V_{OH}$	High-level Output		2.4			V
	Voltage					
$V_{OL}$	Low-level Output				0.4	V
	Voltage					
$V_{CINL}$	Input Clamp Voltage <sup>1</sup>	$I_{CL} = -18mA$			GND -0.8	V
$V_{CIPL}$	Input Clamp Voltage <sup>1</sup>	$I_{CL} = 18mA$			IVCC + 0.8	V
$V_{CONL}$	Output Clamp	$I_{CL} = -18mA$			GND -0.8	V
	Voltage <sup>1</sup>					
$V_{COPL}$	Output Clamp	$I_{CL} = 18mA$			OVCC + 0.8	V
	Voltage <sup>1</sup>					
I <sub>OL</sub>	Output Leakage	High	-10		10	μΑ
	Current	Impedance				

Note: <sup>1</sup>Guaranteed by design. Voltage undershoot or overshoot cannot exceed absolute maximum conditions for a pulse of greater than 3 ns or one third of the clock cycle.

## **DC Specifications**

Under normal operating conditions unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
I <sub>OHD</sub>	Output High Drive Data and	$V_{OUT} = V_{OH}$ ; $ST = 1$	4.2	8	18	mA
	Controls	ST = 0	2.1	4	9	
I <sub>OLD</sub>	Output Low Drive Data and	$V_{OUT} = V_{OL}$ ; $ST = 1$	-5.2	-5.5	-11	mA
	Controls	ST = 0	-2.6	-2.75	-5.5	
I <sub>OHC</sub>	ODCK High Drive	$V_{OUT} = V_{OH}$ ; $ST = 1$	8.5	17	37	mA
		ST = 0	4.2	9	18	
I <sub>OLC</sub>	ODCK Low Drive	$V_{OUT} = V_{OL}$ ; $ST = 1$	-10.4	-16	-23	mA
		ST = 0	-5.2	-8	-11	
$V_{ID}$	Differential Input Voltage		75		1000	mV
	Single Ended Amplitude					
$I_{PD}$	Power-down Current <sup>2</sup>				10	mA
I <sub>CCR</sub>	Receiver Supply Current: $C_{LOAD}$ = 10pF $R_{EXT\_SWING}$ = 510 $\Omega$ With either ODCK=56MHz, 2-pixel/clock mode, or ODCK=112MHz, 1-pixel/clock mode	Typical Pattern <sup>3</sup>		185	240	mA
		Worse Case Pattern <sup>4</sup>		230	310	mA

Notes: <sup>1</sup> Guaranteed by design.

<sup>&</sup>lt;sup>2</sup>The transmitter must be in power-down mode, powered off, or disconnected for the current to be under this maximum

<sup>&</sup>lt;sup>3</sup>The Typical Pattern contains a gray scale area, checkerboard area, and text.

<sup>&</sup>lt;sup>4</sup>Black and white checkerboard pattern, each checker is two pixel wide.

## **AC Specifications**

Under normal operating conditions unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
$T_{DPS}$	Intra-Pair (+ to -) Differential Input Skew <sup>1</sup>	112MHz			360	ps
T <sub>CCS</sub>	Channel to Channel Differential Input Skew <sup>1</sup>	112MHz			6	ns
$T_{IJIT}$	Worst Case Differential Input Clock Jitter tolerance <sup>2,3</sup>	65 MHz			465	ps
		112 MHz			270	ps
D <sub>LHT</sub>	Low-to-High Transition Time : Data and Controls (56 MHz, 2-pixel/clock, PIXS=1)	$C_L = 10pF;$ ST = 1			3.0	ns
		$C_L = 5pF;$ ST = 0			4.7	ns
	Low-to-High Transition Time : Data and Controls (112 MHz, 1-pixel/clock, PIXS=0)	$C_L = 10pF;$ ST = 1			3.1	ns
		$C_L = 5pF;$ ST = 0			5.0	ns
	ODCK (56 MHz, 2-pixel/clock, PIXS=1)	$C_L = 10pF;$ ST = 1			2.0	ns
		$C_L = 5pF;$ ST = 0			2.9	ns
	ODCK (112 MHz, 1-pixel/clock, PIXS=0)	C <sub>L</sub> = 10pF; ST = 1			2.0	ns
		$C_L = 5pF;$ ST = 0			2.8	ns
D <sub>HLT</sub>	High-to-Low Transition Time: Data and Controls (56 MHz, 2-pixel/clock, PIXS=1)	$C_L = 10pF;$ ST = 1			2.8	ns
		$C_L = 5pF;$ ST = 0			3.9	ns
	High-to-Low Transition Time: Data and Controls (112MHz, 1-pixel/clock, PIXS=0)	$C_L = 10pF;$ ST = 1			2.7	ns
		$C_L = 5pF;$ ST = 0			3.7	ns
	ODCK (56 MHz, 2-pixel/clock, PIXS=1)	$C_L = 10pF;$ ST = 1			1.5	ns
		$C_L = 5pF;$ ST = 0			2.5	ns
	ODCK (112 MHz, 1-pixel/clock, PIXS=0)	$C_L = 10pF;$ ST = 1			1.5	ns
		$C_L = 5pF;$ ST = 0			2.3	ns
T <sub>SETUP</sub>	Data, DE, VSYNC, HSYNC, and CTL[3:1] Setup Time to ODCK falling edge (OCK_INV = 0) or to ODCK rising edge (OCK_INV = 1) at 112 MHz	$C_L = 10pF;$ ST = 1	1.7 *1.3			ns
	*OCK_INV = 1	$C_L = 5pF;$ ST = 0	1.1 *0.9			ns
T <sub>HOLD</sub>	Data, DE, VSYNC, HSYNC, and CTL[3:1] Hold Time to ODCK falling edge, (OCK_INV = 0) or to ODCK rising edge (OCK_INV = 1) at 112 MHz, PIXS=0	C <sub>L</sub> = 10pF; ST = 1	5.6 *4.7			ns
	*OCK_INV = 0	$C_L = 5pF;$ ST = 0	6.0 *6.0			ns

Notes:

<sup>&</sup>lt;sup>1</sup> Guaranteed by design.

Jitter defined as per DVI 1.0 Specification, Section 4.6 Jitter Specification.

<sup>&</sup>lt;sup>3</sup> Jitter measured with Clock Recovery Unit as per DVI 1.0 Specification, Section 4.7 *Electrical Measurement Procedures*.

<sup>&</sup>lt;sup>4</sup> Output clock duty cycle is independent of the differential input clock duty cycle and the IDCK duty cycle.

<sup>&</sup>lt;sup>5</sup> Measured when transmitter was powered down (see SiI /AN-0005 "PanelLink Basic Design/Application Guide," Section 2.4).

## AC Specifications (continued)

Under normal operating conditions unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
R <sub>CIP</sub>	ODCK Cycle Time <sup>1</sup> (1-pixel/clock)		8.9		40	ns
F <sub>CIP</sub>	ODCK Frequency <sup>1</sup> (1-pixel/clock)		25		112	MHz
R <sub>CIP</sub>	ODCK Cycle Time <sup>1</sup> (2-pixels/clock)		17.8		80	ns
$F_{CIP}$	ODCK Frequency <sup>1</sup> (2-pixels/clock)		12.5		56	MHz
R <sub>CIH</sub>	ODCK High Time <sup>4</sup> (112MHz, 1-pixel/clock, PIXS = 0)	$C_L = 10pF;$ ST = 1	3.0			ns
		$C_L = 5pF;$ ST = 0	1.1			ns
R <sub>CIL</sub>	ODCK Low Time <sup>4</sup> (112MHz, 1-pixel/clock, PIXS = 0)	$C_L = 10pF;$ ST = 1	3.5			ns
		$C_L = 5pF;$ ST = 0	2.1			ns
T <sub>PDL</sub>	Delay from PD or PDO Low to high impedance outputs <sup>1</sup>				10	ns
T <sub>HSC</sub>	Link disabled (DE inactive) to SCDT low <sup>1</sup>			100		ms
	Link disabled (Tx power down) to SCDT low <sup>5</sup>				250	ms
T <sub>FSC</sub>	Link enabled (DE active) to SCDT high <sup>1</sup>			25		DE edges
T <sub>ST</sub>	ODCK high to even data output <sup>1</sup>			0.25		R <sub>CIP</sub>

Notes:

- <sup>1</sup> Guaranteed by design.
- <sup>2</sup> Jitter defined as per DVI 1.0 Specification, Section 4.6 *Jitter Specification*.
- <sup>3</sup> Jitter measured with Clock Recovery Unit as per DVI 1.0 Specification, Section 4.7 *Electrical Measurement Procedures*.
- Output clock duty cycle is independent of the differential input clock duty cycle and the IDCK duty cycle.

## Setup and Hold Timings for data rates other than 112 MHz:

The measurements shown above are minimum setup and hold timings based on the maximum data rate of 112 MHz. To estimate the setup and hold times for slower data rates (for either different resolutions or 2 pixel per clock mode), the following formula can be used:

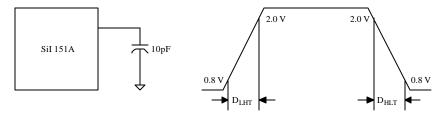
Time (at new frequency) = Time (112 MHz) + (Clock Period at new frequency - Clock Period at 112 MHz)/2

For the case of high strength output (ST=1) with a 10 pf load, and using the standard ODCK (ODCK\_INV = 0), the table below shows the minimum set up and hold times for other speeds as follows:

Data Rate (MHz)	Clock (ns)	setup (ns)	hold (ns)	
112	8.93	1.70	5.60	SXGA 1 pixel/clock
56	17.86	6.16	10.06	SXGA 2 pixel/clock

<sup>&</sup>lt;sup>5</sup> Measured when transmitter was powered down (see SiI/AN-0005 "PanelLink Basic Design/Application Guide," Section 2.4).

## **Timing Diagrams**



**Figure 1. Digital Output Transition Times** 

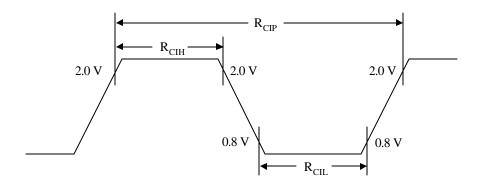


Figure 2. Receiver Clock Cycle/High/Low Times

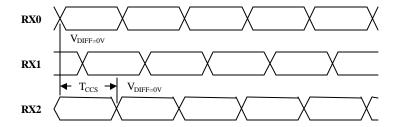


Figure 3. Channel-to-Channel Skew Timing

# **Output Timing**

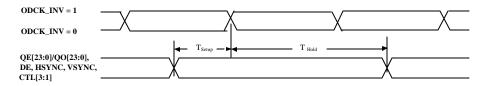


Figure 4. Output Data, DE, and Control Signals Setup/Hold Times to ODCK Falling Edge when ODCK\_INV=0, or ODCK Rising Edge when ODCK\_INV = 1.

## **Output Timing (continued)**

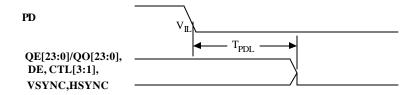


Figure 5. Output Signals Disabled Timing from PD Active

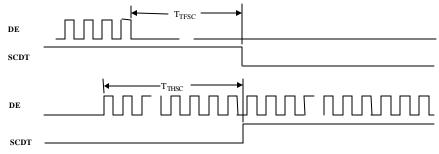


Figure 6. SCDT Timing from DE Inactive/Active

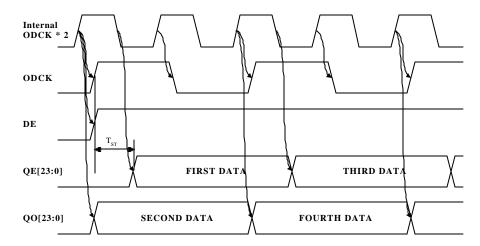


Figure 7. TFT 2-Pixels/Clock Staggered Output Timing Diagram

# **Output Pins Description**

Pin	Pin #	Туре	Description
Name		.,,,,,	
QE23- QE0	See SiI 151A	Out	Output Even Data[23:0] corresponds to 24-bit pixel data for 1-pixel/clock input mode and to the first 24-bit pixel data for 2-pixels/clock mode.
	Pin		Output data is synchronized with output data clock (ODCK).
	Diagram		Refer to the TFT Signal Mapping application note (SiI/AN-0007) which tabulates the relationship between the input data to the transmitter and output data from the receiver.
			A low level on PD or PDO will put the output drivers into a high impedance (tri-state) mode. A weak internal pull-down device brings each output to ground.
QO23- QO0	See SiI 151A	Out	Output Odd Data[23:0] corresponds to the second 24-bit pixel data for 2-pixels/clock mode.
	Pin		During 1-pixel/clock mode, these outputs are driven low.
	Diagram		Output data is synchronized with output data clock (ODCK).
			Refer to the TFT Signal Mapping application note (SiI/AN-0007) which tabulates the relationship between the input data to the transmitter and output data from the receiver.
			A low level on PD or PDO will put the output drivers into a high impedance (tri-state) mode. A weak internal pull-down device brings each output to ground.
ODCK	44	Out	Output Data Clock. This output can be inverted using the OCK_INV pin. A low level on PD or PDO will put the output driver into a high impedance (tri-state) mode. A weak internal pull-down device brings the output to ground.
DE	46	Out	Output Data Enable. This signal qualifies the active data area. A HIGH level signifies active display time and a LOW level signifies blanking time. This output signal is synchronized with the output data. A low level on PD or PDO will put the output driver into a high impedance (tri-state) mode. A weak internal pull-down device brings the output to ground.
HSYNC	48	Out	Horizontal Sync input control signal.
VSYNC	47	Out	Vertical Sync input control signal.
CTL1	40	Out	General output control signal 1. This output is <u>not</u> powered down by PDO.
CTL2	41	Out	General output control signal 2.
CTL3	42	Out	General output control signal 3.
			A low level on PD or PDO will put the output drivers (except CTL1 by PDO) into a high impedance (tri-state) mode. A weak internal pull-down device brings each output to ground.

# **Configuration Pins Description**

Pin Name	Pin #	Туре	Description
OCK_INV	100	ln	ODCK Polarity. A LOW level selects normal ODCK output. A HIGH level selects
			inverted ODCK output. All other output signals are not affected by this pin. They will maintain the same timing no matter the setting of OCK_INV pin.
PIXS	4	In	Pixel Select. A LOW level indicates one pixel (up to 24-bits) per clock mode using
			QE[23:0]. A HIGH level indicates two pixels (up to 48-bits) per dock mode using
			QE[23:0] for first pixel and QO[23:0] for second pixel.
STAG_OUT	7	ln	Staggered Output. A HIGH level selects normal simultaneous outputs on all odd and
			even data lines. A LOW level selects staggered output drive. This function is only
			available in 2-pixels per clock mode.
ST	3	ln	Output Drive. A HIGH level selects HIGH output drive strength. A LOW level selects
			LOW output drive strength.

# **Power Management Pins Description**

Pin Name	Pin #	Туре	Description
SCDT	8	Out	Sync Detect. A HIGH level is outputted when DE is actively toggling indicating that the link is alive. A LOW level is outputted when DE is inactive, indicating the link is down. Can be connected to PDO to power down the outputs when DE is not detected. The SCDT output itself, however, remains in the active mode at all times.
PDO	9	In	Output Driver Power Down (active LOW). A HIGH level indicates normal operation. A LOW level puts all the output drivers only (except SCDT and CTL1) into a high impedance (tri-state) mode. A weak internal pull-down device brings each output to ground. PDO is a sub-set of the PD description. The chip is not in power-down mode with this pin. SCDT and CTL1 are not tri-stated by this pin.
PD	2	ln	Power Down (active LOW). A HIGH level indicates normal operation and a LOW level indicates power down mode. During power down mode, all output buffers are disabled and brought low, all analog logic is powered down, and all inputs are disabled.

# **Differential Signal Data Pins Description**

Pin	Pin #	Туре	Description
Name			
RX0+	90	Analog	TMDS Low Voltage Differential Signal input data pairs.
RX0-	91	Analog	
RX1+	85	Analog	
RX1-	86	Analog	
RX2+	80	Analog	
RX2-	81	Analog	
RXC+	93	Analog	TMDS Low Voltage Differential Signal input data pairs.
RXC-	94	Analog	
EXT_RES	96	Analog	Impedance Matching Control. Resistor value should be approximately ten times the
			characteristic impedance of the cable. In the common case of $50\Omega$ transmission line,
			an external $560\Omega$ resistor must be connected between AVCC and this pin.

## **Reserved Pin Description**

		P 4. 4	
Pin Name	Pin #	Type	Description
RESERVED	1	In	Must be tied LOW for normal operation.
RESERVED	99	In	Must be tied HIGH for normal operation.

# **Power and Ground Pins Description**

Pin Name	Pin #	Type	Description
VCC	6,38,67	Power	Digital Core VCC, must be set to 3.3V.
GND	5,39,68	Ground	Digital Core GND.
OVCC	18,29,43,57,78	Power	Output VCC, must be set to 3.3V.
OGND	19,28,45,58,76	Ground	Output GND.
AVCC	82,84,88,95	Power	Analog VCC must be set to 3.3V.
AGND	79,83,87,89,92	Ground	Analog GND.
PVCC	97	Power	PLL Analog VCC must be set to 3.3V.
PGND	98	Ground	PLL Analog GND.

## **TFT Panel Data Mapping**

The following table shows the output data mapping in one pixel per clock mode for the SiI 151A. This output data mapping is dependent upon the SiI PanelLink transmitters having the exact same type of input data mappings. Please refer to the SiI PanelLink transmitter for the specific input data mappings and to the TFT Signal Mapping application note (SiI AN-0007).

	SiI 151A		
	1-Pixel/Clock Output		
	18bpp	24bpp	
BLUE[7:0]	QE[7:2]	QE[7:0]	
GREEN[7:0]	QE[15:10]	QE[15:8]	
RED[7:0]	QE[23:18]	QE[23:16]	

Table 1. One Pixel/Clock Mode Data Mapping

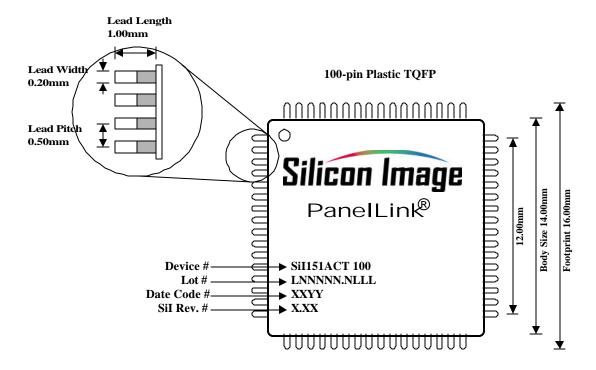
	SiI 151A		
	2-Pixel/Clock Output		
	18bpp	24bpp	
BLUE[7:0] - 0	QE[7:2]	QE[7:0]	
GREEN[7:0] - 0	QE[15:10]	QE[15:8]	
RED[7:0] - 0	QE[23:18]	QE[23:16]	
BLUE[7:0] - 1	QO[7:2]	QO[7:0]	
GREEN[7:0] - 1	QO[15:10]	QO[15:8]	
RED[7:0] - 1	QO[23:18]	QO[23:16]	

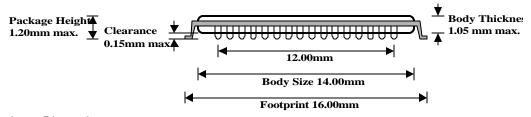
Table 2. Two Pixel/Clock Mode Data Mapping

Note: For 18-bit mode, the Flat Panel Timing Controller interfaces to the SiI 151A exactly the same as in the 24-bit mode; however, only 6bits per channel (color) are interfaced instead of the full 8. As can be seen from the above table, the data mapping for less than 24-bit per pixel interfaces are MSB justified.

## Package Dimensions

# PanelLink<sup>®</sup>





100-pin TQFP Package Dimensions

JEDEC code MS-026 AED

#### **Application Information**

To obtain the most updated Application Notes and other useful information for your design application, please visit the Silicon Image web site at **www.Siimage.com**, or contact your local Silicon Image sales office.

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Ordering Information
Part Number: SiI151ACT100

#### **Revision History**

Revision	Date	Comment
Α	5/00	Full release
В	7/00	Corrections to Figures
С	3/01	Corrections to Functional Block Diagram

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